

View Online at <https://aerobasegroup.com/nsn/8040-01-624-4033>

Physical Form:

Liquid

Quantity Within Each Unit Package:

2.000 grams

Specific Usage Design:

For circuit board bonding and repair applications

Rated Drying Time:

24.000 hours

Special Features:

Room temperature or elevated temperature cure; 24 hours at room temperature, 4 hours at 149 degrees f; service temperature range of minus 67 degrees f to plus 275 degrees f

Color:

Clear

Material:

Plastic epoxy

Supplementary Features:

2 gram kit (pre-measured package)

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fig:

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